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OCT 25 2005

Docket No. MTI-31607

Patent

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Lee, Teck et al.
Serial No. : 10/050,507
Filing Date : January 16, 2002
For : Elimination of RDL Using Tape Base Flip Chip on Flex for Die Stacking
Examiner : THOMPSON, Craig
Confirmation No. : 7687
Group Art Unit : 2813

CERTIFICATION UNDER 37 CFR 1.8(a) and 1.10

I hereby certify that, on the date shown below, this correspondence is being transmitted to **Fax** No. 571-273-8300 addressed to Examiner THOMPSON at the US Patent and Trademark Office.

Date: October 25, 2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

STATUS INQUIRY

Dear Sir:

This application was filed on January 16, 2002, and the last correspondence filed in this application is a Request for Continued Examination (RCE) submitted May 10, 2005.

More than **fifty-seven (57)** months (from the filing date), and **five (5)** months (from the mailing date of the RCE) have passed without receiving any communication from the U.S. Patent and Trademark Office. Please provide us with a status of this application.

Respectfully submitted,

Dated: October 25, 2005

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